

μ IO-Stick

About this document

Scope and purpose

The µIO-Stick is an interface device for controlling Infineon boards/kits during run time through PC.



Intended audience

This document is intended for anyone using a µIO-Stick.

Important notice



Important notice

"Evaluation Boards and Reference Boards" shall mean products embedded on a printed circuit board (PCB) for demonstration and/or evaluation purposes, which include, without limitation, demonstration, reference and evaluation boards, kits and design (collectively referred to as "Reference Board").

Environmental conditions have been considered in the design of the Evaluation Boards and Reference Boards provided by Infineon Technologies. The design of the Evaluation Boards and Reference Boards has been tested by Infineon Technologies only as described in this document. The design is not qualified in terms of safety requirements, manufacturing and operation over the entire operating temperature range or lifetime.

The Evaluation Boards and Reference Boards provided by Infineon Technologies are subject to functional testing only under typical load conditions. Evaluation Boards and Reference Boards are not subject to the same procedures as regular products regarding returned material analysis (RMA), process change notification (PCN) and product discontinuation (PD).

Evaluation Boards and Reference Boards are not commercialized products, and are solely intended for evaluation and testing purposes. In particular, they shall not be used for reliability testing or production. The Evaluation Boards and Reference Boards may therefore not comply with CE or similar standards (including but not limited to the EMC Directive 2004/EC/108 and the EMC Act) and may not fulfill other requirements of the country in which they are operated by the customer. The customer shall ensure that all Evaluation Boards and Reference Boards will be handled in a way which is compliant with the relevant requirements and standards of the country in which they are operated.

The Evaluation Boards and Reference Boards as well as the information provided in this document are addressed only to qualified and skilled technical staff, for laboratory usage, and shall be used and managed according to the terms and conditions set forth in this document and in other related documentation supplied with the respective Evaluation Board or Reference Board.

It is the responsibility of the customer's technical departments to evaluate the suitability of the Evaluation Boards and Reference Boards for the intended application, and to evaluate the completeness and correctness of the information provided in this document with respect to such application.

The customer is obliged to ensure that the use of the Evaluation Boards and Reference Boards does not cause any harm to persons or third party property.

The Evaluation Boards and Reference Boards and any information in this document is provided "as is" and Infineon Technologies disclaims any warranties, express or implied, including but not limited to warranties of non-infringement of third party rights and implied warranties of fitness for any purpose, or for merchantability.

Infineon Technologies shall not be responsible for any damages resulting from the use of the Evaluation Boards and Reference Boards and/or from any information provided in this document. The customer is obliged to defend, indemnify and hold Infineon Technologies harmless from and against any claims or damages arising out of or resulting from any use thereof.

Infineon Technologies reserves the right to modify this document and/or any information provided herein at any time without further notice.



Table of contents

Table of contents

	About this document
	Important notice
	Table of contents
1	Overview
1.1	Description
1.2	Key features
1.3	Block diagram
2	Hardware connection
2.1	Pin assignment
2.2	Examples
3	µIO-Stick firmware update
4	FastLIN BSL support
4.1	Installation guideline
4.2	BSL tool
4.2.1	The configuration dialog
4.2.2	Establish a connection
4.2.3	Loading a HEX File
4.2.4	Basic Mode
4.2.5	Expert Mode
4.2.5.1	Get and set NAC and NAD values19
4.2.5.2	Read and write 100TP pages
4.2.6	BSL actions
4.2.6.1	Auto Execute
4.2.6.2	Erase
4.2.6.3	Download
4.2.6.4	Verify
4.2.6.5	Protection enable/disable 23
4.2.6.6	Run
4.2.6.7	Read Out
4.3	Command line tool
4.4	FAQ
4.5	Updates and purchases
5	Run-time control - programming and monitoring
5.1	Installation guideline
5.2	Config Wizard
6	Acronyms
	Revision history

Table of contents



1 Overview



1 Overview

1.1 Description

The µIO-Stick is an interface device for controlling Infineon boards/kits during run time through PC. It enables the connection between the evaluation board and USB for SPI programming and monitoring. Besides, it plugs into the evaluation board via a standard 16-pin connector and allows easy interface to the microcontroller via USB for communication through SPI, LIN. It also implements GPIO ports, PWM generation up to 20 kHz and an analog measurement interface (ADC).

The μ IO-Stick provides two exclusive functions:

1. Infineon MOTIX[™] MCU FastLIN BSL support

The Infineon MOTIX[™] MCU devices provide a built-in bootstrap loader (BSL) for programming the MOTIX[™] MCU devices over the built-in LIN transceiver. The µIO-Stick acts as an interface between the MOTIX[™] MCU device and a PC. It handles the BSL protocols as well as the physical layers. A PC application provides access to all BSL functions of the MOTIX[™] MCU device.

Supported MOTIX[™] MCU ICs:

- TLE983x family
- TLE984x family
- TLE985x family
- TLE986x family
- TLE987x family
- 2. Run-time control programming and monitoring

The µIO-Stick connects the Evaluation Board with the computer. Via the ConfigWizard software – a powerful and intuitive graphical user interface (GUI) – the user gets a customized programming, monitoring and evaluation support for various Infineon automotive products.

Supported devices:

- System Basis Chip (SBC)
- DC Motor System ICs
- High/low Side Switch (Spider+, SPOC[™])
- Half and Full Bridge Driver

1.2 Key features

The μ IO-Stick provides the following features:

- Communication with the connected device via LIN, SPI
- Four GPIOs
- PWM signal generation up to 20 kHz
- Measurement of analog voltages up to 20 V
- Read and keep functionality to detect reset of the connected device
- USB HID device, no additional driver installation required
- µIO-Stick can power a target device
- Connected device can also be powered by external power supply for higher current
- 3 on-board status LEDs
- Additional BSL updater GUI for BSL communication with MOTIX[™] MCU devices

1 Overview

1.3 Block diagram

The µIO-Stick consists of an XMC4200 micro-controller which provides the necessary hardware interface and handles the USB and BSL protocols.

LIN and RS232 are implemented as true physical layers (using LIN and MAX transceivers), while the digital lines (SPI, GPIOs) provide a 5V-TTL level.

In addition, a small switchable charge-pump is implemented to generate a +12 V/200 mA supply for the target device and the integrated LIN transceiver.

VREGImage: Constant of the second second

Figure 1

µIO-Stick block diagram





2 Hardware connection

2.1 Pin assignment

The μ IO-Stick provides two interfaces: The USB interface to be plugged into the PC and a 16-pin header to access the BSL interface. Figure 2 provides a view into the 16-pin header of the μ IO-Stick, including the pin numbering.



Figure 2 µIO-Stick pin view

Table 1 lists the pin usage of the 16-pin header. The gray shaded pins are not used for BSL functions and therefore they are not considered further.

PIN	Description
1	RS232-TxD (out)
2	GND
3	RS232-RxD (in)
4	+5 V (USB, out)
5	LIN (physical, in/out)
6	VS (target supply, in/out)
7	Target Reset (5 V, out)
8	GPIO3 (5 V, in/out)
/	I

Table 1µIO-Stick pin assignment



Table 1	(continued) µIO-Stick pin assignment
PIN	Description
9	SPI/CS(5 V, out)
10	GPIO2 (5 V, in/out)
11	SPI CLK (5 V, out)
12	GPIO1 (5 V, in/out)
13	SPI MISO (5 V, in)
14	GPIO0 (5 V, in/out)
15	SPI MOSI (5 V, out)
16	analog in (max. 18 V)

Note: The RS232 pins are no TTL pins but real RS232 levels (MAX232 driven).

Pin 5 - LIN This is the LIN bus connection to the LIN transceiver implemented in the µIO-Stick. It is suited to drive a corresponding LIN input of the target system.

Pin 7 - Target Reset This pin is intended to drive the reset input of the target device in order to synchronize the device state with the attempts to establish a BSL connection. The connection of this pin to the reset of the target device is not necessarily required as synchronization can also be achieved by:

- Power cycling of the target device by pin 6 (VS)
- Keeping the target device in BSL mode by configuring an appropriate NAC value

Pin 2 - GND This is the common ground connection to the target system.

Pin 6 - VS This pin can either be driven from the implemented charge-pump of the µIO-Stick (+12 V/200 mA) or can be overridden by an external supply, for example the supply of the target device. This pin is also used to internally drive the LIN transceiver available on the µIO-Stick. If BSL communication over the LIN interface is intended, then the supply of pin 6 is mandatory.



2.2 Examples

Figure 3 shows the minimum required connection from the µIO-Stick to the target device in order to establish a BSL communication over the LIN interface. This applies to both Normal-LIN and FastLIN protocols. To be able to establish a BSL connection, the target device either has to stay in BSL mode upon power-up (fresh device), or a power cycling (VS - pin 6) done by the µIO-Stick is required.

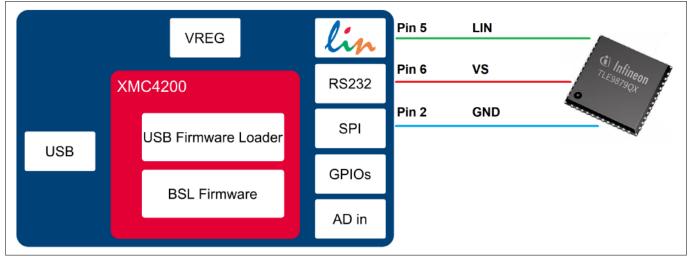


Figure 3

Normal LIN and FastLIN connection, without reset, target supplied by µIO-Stick

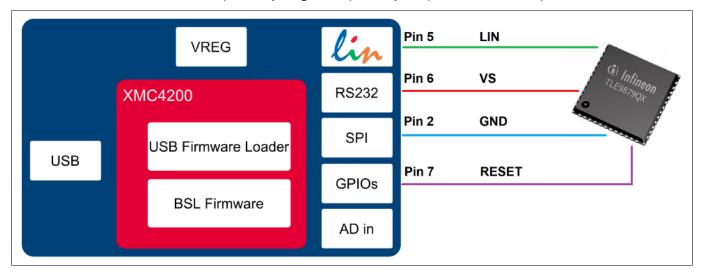


Figure 4 shows a connection scenario with reset. The µIO-Stick actively resets the target device in order to start BSL communication. In this case a power cycling of VS (pin 6) by the µIO-Stick is not required.

Figure 4

Normal LIN and FastLIN connection, with reset, target supplied by μ IO-Stick



Figure 5 shows a connection example where the target device and also the µIO-Stick are supplied by a separate power supply. Since in this case the µIO-Stick would not be able to perform a VS power cycling to restart the device it is wise to connect the reset line as well. If the target device stays in BSL mode upon power-up, such as for a new, unprogrammed device, then the reset line is not required.

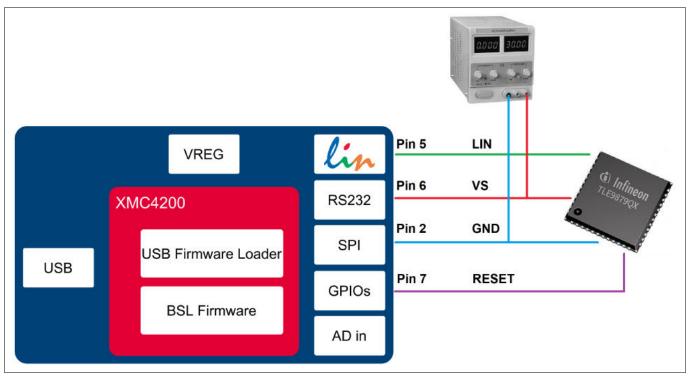


Figure 5 Normal LIN and FastLIN connection, with reset, target supplied by separate power supply



Figure 6 shows another example of how to connect the µIO-Stick to the target device, by simply plugging the ribbon cable to the BSL connector of the evaluation board. Hereby only the LIN interface is supported.

Figure 6

Direct connection of µIO-Stick to evaluation board

infineon

3 µIO-Stick firmware update

3 µIO-Stick firmware update

The µIO Stick comes with the capability to update the firmware of the integrated XMC4200 micro-controller either to provide new features to the customer or to be able to correct issues with the firmware.

To update the firmware, the file **uIO-Updater.exe** and a HEX file are required. uIO-Updater.exe is a command line tool, where the hex file to be loaded has to be given as command line input. For example:

```
C:\>uIO-Updater.exe -FW="bsl_1.1.346.fw"
```

The example above flashes the file BSL_V1.1.346.hex into the μ IO-Stick. After the firmware update has finished, unplug the μ IO-Stick from USB and reconnect it.



4 FastLIN BSL support

There are two software components required to use the BSL feature of the target device. Part 1 is the firmware of the XMC4200 microcontroller mounted on the µIO-Stick. This firmware is responsible to generate the BSL communication protocol. Part 2 is the BSL user software running on a Microsoft Windows PC. It provides the user interface and prepares the data packets to be sent to the µIO-Stick and further to the target device.

4.1 Installation guideline

- 1. Go to the section Tools & Software of the µIO-Stick
- 2. Download uIO_BSL_Tool.zip and extract all the files
- 3. Connect the µIO-Stick via USB to the PC and via the 16-pin connector to the target device
- 4. Update the µIO-Stick with the current BSL firmware version by executing the script **UpdateBSL**
- 5. Launch the application **BSL_Tool.exe**

4.2 BSL tool

The BSL GUI tool is the user interface to control the BSL interactively. It provides two modes of operation, a Basic Mode and an Expert Mode.

4.2.1 The configuration dialog

Before a BSL connection is established, the target device and the BSL interface and protocol have to be selected. The **Configuration** block lists the currently selected target device, while the status bar at the bottom of the window displays the selected BSL protocol and baud rate. In order to change these settings, press the **Change** button inside the configuration block. Please also refer to Figure 7.

 IFX ePower BootStrapLoader - Basic Mode File Extra Help 					
Connection NAD: 255 Connect DownloadNvm Hex File Selected Hex File: <no file="" hex="" selected=""></no>	Configuration TLE9831	Change	Load	Downloa	
Normal LIN 19200			disconr	nected	

Figure 7 BSL tool - configuration

Figure 8 displays the **BSL Configuration** dialog. Here the user selects the desired target device, BSL protocol, baud rate, and the behavior of the integrated VS charge pump.



👄 BSL Confi	guration			×
Target device:	TLE9879QX BF-Step	1		~
Protocol:	Fast-LIN ×	2		
Baud rate:	115200 ×	3		
Pin VS:	OFF during RESET V	4		
VS	t _{OFF}		t OFF: 300	ms 5
LIN		t _{LIN}	t LIN: 6ms	~ 6
	Cancel		7 Set Co	onfiguration

Figure 8

BSL tool - Configuration dialog

- 1. Target Device select the target device from the pull-down list
- 2. **Protocol** select the desired BSL protocol and BSL interface:
 - Normal LIN BSL communication uses real LIN frames, Master-Request frames, and Slave-Response frames. In order to distinguish these BSL LIN frames from real LIN frames, the checksum is inverted. Communication is done via the LIN transceiver that is integrated in the target device.
 - Fast-LIN UART like BSL communication using the device integrated LIN transceiver. This is the default protocol for new, unprogrammed devices
- 3. Baud Rate select the communication baud rate
- 4. **Pin VS** select the behavior of the VS pin:
 - OFF the µIO-Stick integrated charge pump is switched off, VS must be supplied by the target system, see also Figure 5 on page 10.
 - ON the µIO-Stick integrated charge pump is switched on, and remains on. Please see also Figure 4.
 - OFF during Reset the µIO-Stick integrated charge pump is switched off during the reset phase before the connection attempt is started, see also Figure 3. This setting is meant to provide a power-on reset and can be used in case the RESET pin of the target device is not accessible.
- 5. **tOFF** defines the duration of the RESET pulse in ms. If **Pin VS** is set to OFF during RESET this setting is applied to the reset pulse of both the RESET pin and VS pin. If **Pin VS** is set to OFF or ON, this setting is only applied to the reset pulse of the RESET pin.
- 6. **tLIN** defines the delay between the release of the reset pulse and the first connection sequence
- 7. Set Configuration click to apply the selected setting and close the BSL Configuration dialog.

Once a configuration is selected, it can be saved as an XML file by clicking the **Save** button. A previously saved configuration XML file can be loaded by clicking the **Load** button. These functions can also be selected in the menu **File**, see Figure 9.



 IFX ePower BootStrapLoader - Basic Mode File Extra Help 			-		×
NAD: 255 Connect	Configuration TLE9879QX	Change	Load	Sav	e
DownloadNvm Hex File Selected Hex File: <no file="" hex="" selected=""></no>	inec) n			
				Downloa	d
Fast-LIN only 115200			disconr	nected	

Figure 9

BSL tool - configuration menu

4.2.2 Establish a connection

Once the configuration has been completed, the connection to the target device can be established. If the μ IO-Stick is not connected to the PC system, the **Connect** button is shaded gray, as shown in Figure 10.

Connection	Configuration				
NAD: 255 Connect	TLE9879QX	Change	Load	Sav	/e
DownloadNvm Hex File Selected Hex File:	rine	<u>0n</u>			
<no file="" hex="" selected=""></no>					
			<u> </u>		
			1	Downloa	ad

Figure 10 BSL tool - no µIO-Stick found

Once the μ IO-Stick is recognized by the BSL tool the **Connect** button turns orange. By pressing the button, the BSL tool tries to establish a connection using the selected BSL interface and BSL protocol. The NAD value used for connection is set to 255 by default. If required, it can be changed.



NAD: 255 Connect		[
Connect	TLE9879QX	Change Load	d Save
DownloadNvm Hex File	TINO	nn	
Selected Hex File:			
<no file="" hex="" selected=""></no>			



BSL tool - ready to connect to target system

IFX ePower BootStrapLoader - Basic Mode		-		×
File Extra Help Connection NAD: 255 Disconnect DownloadNvm Hex File Selected Hex File: <no file="" hex="" selected=""></no>	Configuration TLE9879QX BF-Step Change	Load	San	
Fast-LIN only 115200		connec	ted	

Figure 12 BSL tool - Connected

Figure 12 displays the connected state. The **Connect** button turns into a **Disconnect** button. The status bar at the bottom of the window shows connected.

4.2.3 Loading a HEX File

The main use of the BSL tool is downloading a HEX file that contains the user application code. Via the menu **File** a HEX file can be chosen and loaded, see Figure 13. This step can be done before or after connecting to the target device because it does not program the HEX file to the target device yet.



e File	IFX ePower BootStrapLo Extra Help	ader - Basic Mode			-		×
	Load Hex File Load Config Save Config Set config Exit Rected Hex File:	nnect	Configuration TLE9879QX BF-Step	Change	Load	Downlo	
Fas	t-LIN only 115200				connec	ted	



4.2.4 Basic Mode

The Basic Mode provides a reduced user interface limited to the minimum required actions, which are **Erase**, **Download**, **Verify**, and **Run of code** on the target device. After a connection was established and a HEX file was loaded, all mentioned actions are executed consecutively by clicking the button **Download**. The status bar on the bottom shows the currently running action. After successful download and run, the BSL tool disconnects automatically.

Figure 14 shows the user interface of the Basic Mode during download.

 IFX ePower BootStrapLoader - Basic Mode 			_		×
File Extra Help					
Connection NAD: 255 Disconnect DownloadNvm Hex File Selected Hex File: C:\Users\\ <xxx>\Documents\TLE9879Running</xxx>	ineo	hange	Load	Sav	
Fast-LIN only 115200	DOWNLOAD		connec	ted	



BSL tool - Basic Mode



4.2.5 Expert Mode

The Expert Mode provides more functionality, all functions of the BSL modes supported by the target device are available in this mode. In order to switch to Expert Mode from Basic Mode, select **Expert Mode** in menu **Extra**, as shown in Figure 15.

IFX ePower BootStrapLoader - Basic File Extra Help	Mode	_		×
Cont Check for Update NAD: 255 Connect	Configuration TLE9879QX BF-Step Change	Load	Sa	ive
DownloadNvm Hex File Selected Hex File: C:\Users\ <xxx>\Documents\TLE987</xxx>	Runninglights her			
C. (OSCIS (CAAAS (DOCUMENTS (TEESO)			Downlo	bad
Fast-LIN only 115200		discon	nected	

Figure 15 BSL tool - switch to Expert Mode

Figure 16 displays the user interface of the Expert Mode. The Expert Mode enables all possible BSL actions, including target device erase, code download, device protection, code execution, and code upload. The arrangement of these functions in the GUI is kept in the natural order of execution of these actions, such as the erase function at the top, followed by download, verify, and so on.



FX ePower BootStrapLoader - Expert Mode	- 0	×
e Extra Help		
AD: 255 Disconnect	Configuration TLE9879QX BF-Step Change Load Save	
Operation Auto Execute Auto Exec Erase Download Verify Protection Run Erase Erase • Full Chip • Rangefrom 0x11000000 auto execute • Used Sections to 0x110 Download • Verify Download • NAC: 45 auto execute • NAD: 01 • auto execute Protection disable • auto execute Run Run Run Run Run Run Run Run	Logging Save as BSL starting bootloader	< >

Figure 16 BSL tool - Expert Mode

4.2.5.1 Get and set NAC and NAD values

In Expert Mode, the BSL tool offers the option to change the NAC and NAD values. In the menu **Extra**, **Get/Set NAC/NAD** can be selected as shown in the figure below. This opens the **Change NAC/NAD Settings** dialog which shows the NAC and NAD value of the currently connected device (see Figure 18). The values can be changed and set with the **Set** button.



 IFX ePower BootStrapLoader - Expert Mode ile Extra Help 	- ×
Expert mode Con Check for Update	Configuration TLE9879QX BF-Step Change Load Save
Or Read TP100 Page	Logging
A Write TP100 Page Auto Exec	Save as Clear
Erase Download Verify Protection Run	BSL starting bootloader



BSL tool - get and set NAC/NAD value

- NAC	/NAD Settings Dialog	×
Change	e NAC / NAD Settings 0x01	
NAD	0x FF decima	
	Cancel Set	

Figure 18 BSL tool - change NAC/NAD Settings Dialog

4.2.5.2 Read and write 100TP pages

In Expert Mode, the BSL tool enables the user to read or write 100 times programmable pages of the target device. Via the menu **Extra**, the read or write 100TP operation can be selected.

In the Read TP100 Pages dialog

- **1.** Select the page to be read via the drop-down menu
- 2. Select a location and file name for the resulting HEX file via the ... button
- 3. Click Read selected TP100 page
- 4. The process bar shows the status of the reading page operation



Read TP100 Pag	jes	—		×
TP100 Dialog				
Page to read	Page 3 Y 1			
Hex File Name	C:\Users'\ <xxx>\Documents\TLE9879_tp100_page3_readout.hex</xxx>			
Reading Page	4	Read sele TP100 pa		3
		Clo	ose]

Figure 19 BSL tool - Read TP100 Pages dialog

In the Program TP100 Pages dialog

- **1.** Select the page to be programmed via the drop-down menu
- 2. Select the HEX file that is to be written to the 100TP page via the ... button
- 3. Click Program selected TP100 page
- **4.** The process bar shows the status of the programming operation

Program TP100 P TP100 Dialog				×
Page to program	Page 3 Y			
Hex File Name	C:\Users\\ <xxx>\Documents\TLE9879_tp100_page3_write.hex</xxx>			
Programming	4	Program TP100 pa		3
		C	Close	

Figure 20 BSL tool - Program TP100 Pages dialog

4.2.6 BSL actions

Once the desired Hex file has been selected, the supported BSL actions can be executed. The order of the actions placed on the GUI follows a natural flow: Erase \rightarrow Download \rightarrow Verify \rightarrow Protection \rightarrow Run.

4.2.6.1 Auto Execute

Each of these action groups provides an **auto execute** check box. If it is checked, the corresponding action is added to the **Auto Execute** list.Figure 21 shows an example of the Auto Execute list, where everything except "Protection" is added to the list. By pressing the **Auto Exec** button, the actions added to the list are executed with a single click.



Connection	Configuration
NAD: 255 Disconnect	TLE9879QX BF-Step Change Load Save
Operation Auto Execute	Logging
Auto Exec Erase Download Verify Protection Run	Save as Clear BSL starting bootloader
Erase	user ERASE - auto execution enabled
Erase Full Chip Rangefrom 0x110 00000	user DOWNLOAD - auto execution enabled user VERIFY - auto execution enabled user RUN - auto execution enabled
✓ auto execute ○ Used Sections to 0x1101EFFF	
Download Verify	
Download NAC: 45 Verify	
☑ auto execute NAD: 01 ☑ auto execute	
Protection	
disable ~	
Run	
Run	
☑ auto execute	
Read Out	
Read Out Range from 0x11000000 to 0x1101EFFF	
	v

Figure 21 BSL tool - Auto Execute

4.2.6.2 Erase

The action **Erase** performs an erase of the target device built-in NVM module. The user can select between various sections of the NVM to be erased, which are:

- Full Chip the entire user accessible NVM is erased
- Range from ... to ... only the user defined range is erased
- Used Sections only those NVM regions occupied by the selected HEX file are erased

4.2.6.3 Download

The action **Download** transfers a loaded HEX file into the target device.



4.2.6.4 Verify

The action **Verify** is used to check the integrity of the code inside the target device NVM against the selected HEX file.

4.2.6.5 Protection enable/disable

The action **Protection** either enables or disables the protection of the target device. Depending on the selected target device, the GUI is adapted to the respective protection concept.

Protection of TLE986x and TLE987x devices

For enabling or disabling the protection, the protection action needs to be added to the Auto Execute operation. When the auto execute tick box is ticked, a password dialog opens up. The user has to enter an 8-bit password, as shown in Figure 22

Password Dialog Password Confirmation -			×
Password (1254)	254	✓ decimal	
Cancel		Set	

Figure 22 BSL tool - Password Dialog for TLE986x and TLE987x devices

If a password is set, this is stated in red inside the **Protection** field, as shown in Figure 23.

Note: Before each enable or disable action, the auto execute tick box needs to be unticked and ticked again in order to open the Password Dialog and enter the password.



Operation Auto Execute Auto Exec Erase Download Verify Protection Run
Erase Image: Full Chip Rangefrom 0x11000000 auto execute Used Sections to 0x1101EFFF
Download Verify Download Verify auto execute auto execute
Protection password set 0xFE enable ~ Image: state of the secure password set
Run auto execute

Figure 23 BSL tool - password set and ready to be sent for TLE986x and TLE987x devices

If the target device is not protected, more actions can be added to the auto execute operation, so that enabling the protection is part of the download flow. If the target device is protected, the (disable) protection action can also be executed separately by clicking the **Auto Exec** button.

If the protection is set, the target device does no longer accept any NVM change operations, nor allows code readout. In addition, the SWD interface (ARM) or the DAP interface (8051) is disabled.

To reset the protection status, the same matching 8-bit password used to set the protection has to be provided in the password dialog. If the password matches, the entire NVM of the target device is erased. The target device is fully accessible again.

Protection of TLE984x and TLE985x devices

For TLE984x and TLE985x devices the protection can be set specifically for BSL, code and data. For each protection a separate password can be set in the corresponding field. To execute the protection, either click on each **Execute** button or add required protection actions to the auto execute operation by ticking the boxes for required protection in addition to the tick box for auto execute. Figure 24 shows an example of how to add enabling read/write protection for code and data to Auto Execute.



Operation Auto Execute	
Auto Exec Erase Download	Verify Protection Run
Erase Full Chi auto execute Used Se	
Download NAC:	C: 01 Verify
Protection BSL 0x1122AA55	R/W v disable v Execute
Code 0x1122AA55	R/W v enable v Execute
✓ Data M 0x1122AA55 ✓ auto execute	R/W v enable v Execute
Run Run auto execute	

Figure 24 BSL tool - enable read/write protection for TLE984x and TLE985x devices

Note: A device reset is required for the protection to take effect. To reset the device, disconnect and (re-)connect the BSL tool.

4.2.6.6 Run

The action **Run** starts the execution of the code inside the target device. It terminates the BSL connection..

4.2.6.7 Read Out

The action **Read Out** is available for the protocol FastLIN. It is not available for Normal LIN. It reads and transfers the target device NVM content to the PC system. The user has to define the address range to be read.



4.3 Command line tool

In order to run the BSL actions none-interactively, a command line BSL tool is provided. It is named **BSL_Cmd.exe**, and should be run from a terminal window. Executing BSL_Cmd.exe without any parameters generates a list of the supported options, as shown below:

```
C:\>BSL_Cmd.exe
-----
Bootstrap Loader Command Line Tool v1.2 build 638
_____
FRROR
              : missing arguments
Valid commands are:
                       connection mode and baud rate
-Cmode=baud,NAD
-EF
                       erase full chip
-ER=start-end
                       erase range
-D="hex_file"
                       download hex file (repeatable)
-VS=n
                       function of VS pin. 0: off, 1:on, 2:off during reset
-V=1
                       verify after download
-PS=password
                       set protection
-PR=password
                       reset protection
-R100TP=page, "hex_file" read the selected 100TP page and save it
-RO="hex_file",start-end read out range into hex
-R=NVM
                       run in NVM
-R=RAM
                       run in RAM
-T=device
                       target device
-NACNAD=nac, nad, bslMode set NAC, NAD and BSL mode (F:fastLIN, L:LIN)
-W100TP=page, "hex_file" write hex file to selected 100TP page
-Q
                       quite mode
             : N/F/FO/U N=Normal LIN, F=Fast-LIN, FO=Fast-LIN-only, U=UART
mode
             : baud rate 9600..115200
baud
             : defines the hex file for the download
hex_file
             : selects 100TP page (1..8)
page
start
             : defines the start address for the operation
end
             : defines the end address for the operation
             : defines the target device (s. TargetConfiguration.xml)
device
```

The code above shows a call of BSL_Cmd.exe with various options, which are:

- -CFO=115200,1 : Fast-LIN-only, 115200 baud, NAD = 1
- -T=TLE9879QX : target device TLE9879QX, it has to match the device select list in the configuration dialog
- -VS=1 : VS (Pin 6) on all the time
- -EF : Erase full chip
- -D="Blinky.hex" : downloads the Blinky.hex file to the target device
- -PS=0x55 : sets protection with the 8-bit password 0x55



4.4 FAQ

Why does the connection fail?

- Check if the NAD value is correct or change to NAD=255
- Check the NAC value. If the NAC value is very small, the BSL tool might not be able to establish a connection
- For better performance of the µIO-Stick hardware, use a powered USB hub to ensure stable voltage at VS
- If power-on reset with VS is used, large capacitors at the VS pin might prevent a proper reset. Adjust reset timings to ensure a proper reset and adjust the timing for the beginning of the connection sequence, so that the NAC window is not missed

Why is it not possible to read a 100TP page?

• Check whether the device is (read) protected. If so, disable the protection before reading a 100TP page Why is it not possible to program a 100TP page?

- Check whether the device is protected. If so, disable the protection before reading or writing a 100TP page
- Check whether the page has already been written 100 times. In order to do so, read the page and check the write counter. Please refer to the firmware user manual for more details
- Check whether you are trying to write a section that is write protected. There are sections that are preloaded prior to shipment and cannot be modified by the user, for example to store a device ID. In case the user tries to write these values, an error is reported and the original content is preserved

Why is the protection not enabled (or not disabled) after setting (or clearing) it?

• A restart is necessary to activate enabling (or disabling) the protection. To do this, the device can be disconnected and connected again with the BSL tool

Why is it not possible to clear the BSL protection of a TLE984x device?

• For TLE984x devices, the protection of CBSL is permanent. If a wrong password is sent, the whole device is erased including the protection. For further details please refer to the TLE984x firmware user manual

Why is it not possible to erase or program a TLE984x device, when only read protection is enabled?

• For TLE984x devices, the read protection does not allow any write operations via LIN BSL or SWD, however, write operations from within the device are still possible, for example for updating the firmware. For further details please refer to the TLE984x firmware user manual

Why is it not possible to enable the CBSL protection?

• Check the size of the CBSL. If it is zero, so technically the CBSL does not exist, no protection can be set



4.5 Updates and purchases

For updates of the BSL tool software or the µIO-Stick firmware as well as for purchasing the µIO-Stick, please visit www.hitex.com/uio.



5 Run-time control - programming and monitoring

5.1 Installation guideline

- **1.** Download and install the Infineon Toolbox
- 2. Select the tab "Manage tools", search for SBC, and click "Install"

Infineon Toolbox - Launcher	neon tools in one place (2018.14.0)			- 🗆 X
Infineo Toolbo	Tools • <u>sbd</u>			0 🖂 🏟 🗗
BR S	QR code My tools Manage tools			
c —	A B C D E F G H I J K L M N O P Q R S Config Wizard for SBC Config Wizard for SBC allows easy configuration of Automotive SBC products.	⊤ U V	W X Y Z Version: 2.1.0.201807061335 Tags: ATV, SBC, Config Wizard	Install Details

Figure 25

Installation of Config Wizard for SBC

3. Select the tab "My tools". If the installation was successful, you should see the icon for "Config Wizard for SBC"

Infineon Toolbox - Infineon tools in one place (2018.14.0) suncher		- 0
Infineon Toolbox	Toots Search for tools	0 🖂 🕸 🗗
器 Scan QR code My tools M	inage tools	
Config Wizard for ePower Details	Start	

Figure 26 Config Wizard for SBC installed successfully

4. Click on "Start" and select the required chip.



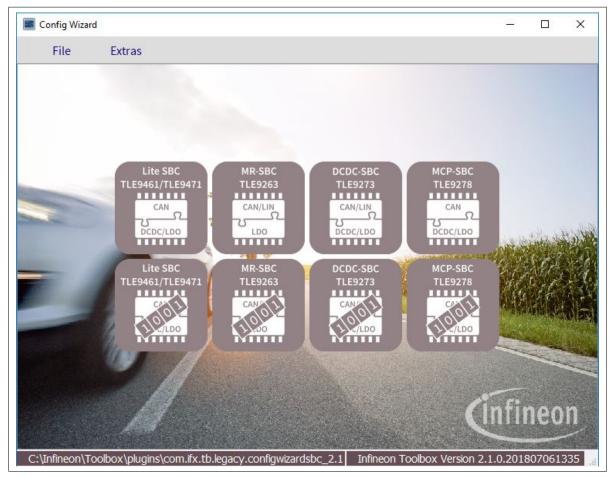


Figure 27 Chips for SBC in Config Wizard

For example, here with the TLE9278-3QX Evalboard correctly supplied, the following screen should display:

File Extras							
Connection Status / Signalisation Pin Status			Status				
uIO Stick connected	Target IC accessable	uIO Fimware Version: 2 . 2 . 1	Thermal Status	Supply Status 1	Supply Status 0	SMPS Status	Device Status
RSTN Pin activated	INT Pin activated	FO Pin activated	VCC1 OT BOOST OT	VB UV BST	POR VIO SC	BST ACT BST SH	DEV STAT1
Control Function MCP-58C			TSD2	VEXT OC	VIO UV FS	BST OP BCK SH	SPI FAIL
Mode	BOOST 6.7 V V	ADC / VIO ADC Result: 0 V	O TPW	VEXT OT VIO OV VIO WARN		BCK OP	CLEAR
NORMAL SLEEP STOP Soft Res	VEXT	ADC connected to WK ADC con. to VBSENSE	CLEAR	CLEAR	CLEAR	CLEAR	WD FAIL1
Normal Sleep / FS Stop Soft Reset	□ VEXT 5.0 V ▼	UV Thresh. VRT1 V	Bus Status 0	Bus Status 2	Bus Status 3	Wake Level Status	Wake Status 0 + 2
CAN / Buck / BOOST / Watchdog Wate-up / Woltage Sensing / FO / RSTN CAN Configuration Buck / BOOST Configuration Watch		Watchdog (WD)	CANTOD SYSERRO CANO FAIL1 CANO FAIL0	CANTO2 SYSERR2 CAN2 FAIL1	CANTO3 SYSERR3 CAN3 FAIL 1 CAN3 FAIL 0		PFM PWM CAN0 TIMER WK
CAN1 OFF PWI CAN2 OFF When e CAN3 OFF	m. transition from PFM to PWM in Stop Mode 1 of Buck Conv. enabled by WK pin ntering Stop Mode switch from PFM to PWM r 100 us	Time-out Watchdog Window Watchdog WD active in Stop Mode Start WD after CAN Wake	O VCAN UV	CANTO1 SYSERR1 CAN1FAIL1 CAN1FAIL0		VBAT UV	CLEAR VBAT UV CAN3 CAN2 CAN1
CANO Slew Rate Control off O afte		After 3 consecutive WD fails: O Continue reset generation	CLEAR	CLEAR	CLEAR		CLEAR
CAN2 Slew Rate Control off Swit	ch off BOOST on low voltage @VBSENSE	Continue reset generation Stop reset generation					
			CLEAR	DIAGNOSTIC STATUS	STOP	PERIODICAL READ OF S	STATUS REGISTER

Figure 28

Config Wizard with SBC TLE9278



Warning:	Please ensure that the latest firmware is flashed onto the µIO-Stick. Otherwise, select the
	tab "Extra", then click "Update uIO".

Infine Toolb		Wizaro	b
File	Extras		
	Settings		
	Open XML	Ctrl+O	
	Reopen XML	Ctrl+R	
	Search GUI element	Ctrl+F	
	Show differences		
e,	Expand branch	Ctrl++	
e,	Collapse branch	Ctrl+-	
	Get uIO version		
	Update uIO		
	Run script file		
	Record script	Ctrl+M	
	Add script command	Ctrl+A	

Figure 29

Select Extra > Update uIO...

Select the file "uIO_V221.hex" and click "OK".

ile Open Firmware	file			
$\leftarrow \rightarrow \cdot \uparrow$	w application > uIO-Stick_Firmware	5~	Search uIO-Stick_	Firmware
Organize 🔻	lew folder		8	
 ✓ Quick acces O Device TLE Desktop ✓ Download: ② Document ■ Pictures ■ Blandine 	8 x ul0_V220.hex ul0_V221.hex		Date modified 06.07.2018 15:35 06.07.2018 15:35	Type HEX File HEX File

Figure 30

Select HEX file with the right version for µIO-Stick



When the update is completed, the µIO Firmware version should be 2.2.1.

5. Repeat step 1 to 4 for the ConfigWizard for Motor System IC, if required.

5.2 Config Wizard

The Config Wizard is a Graphical User Interface which provides an easy access to SBC features and the SPI registers.

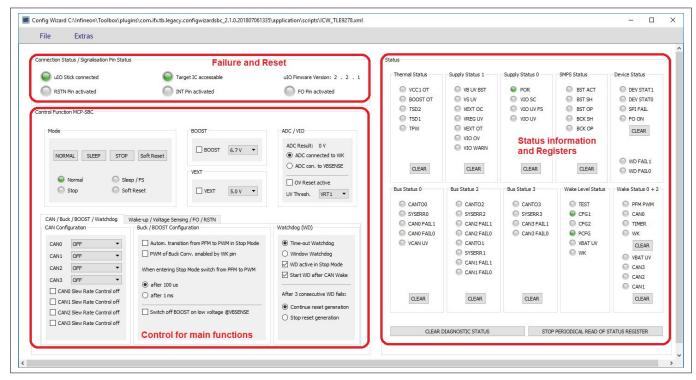


Figure 31

Config Wizard Graphical User Interface



NORI	(State M	achine)	BOOST Boost Control	ADC / VIO ADC Result: 0 V ADC connected to WK
-	Normal Stop	Sleep / FS	VEXT VEXT Control	 ○ ADC con. to VBSENSE ○ OV Reset active UV Thresh. VRT1 ▼
	ck / BOOST / Watch iguration		e Sensing / FO / RSTN Configuration	Watchdog (WD)
CAN0	OFF		transition from PFM to PWM in Stop Mode	Time-out Watchdog
CAN1	OFF	▼ PWM of	Buck Conv. enabled by WK pin	O Window Watchdog
CAN2	OFF	▼ When enter	ing Stop Mode switch from PFM to PWM	WD active in Stop Mode
CAN3	OFF		10 us	Start WD after CAN Wake
_	10 Slew Rate Contro 11 Slew Rate Contro	ol off O after 1		After 3 consecutive WD fails:
	12 Slew Rate Contro	ol off 🛛 🗌 Switch d	off BOOST on low voltage @VBSENSE	Continue reset generation
_	13 Slew Rate Contro	ol off	Buck Control in	 Stop reset generation Watchdog

Figure 32

Config Wizard Control Functions



6 Acronyms

6 Acronyms

The following table summarizes the acronyms and their meanings throughout this document.

Table 2 Acronyms			
Acronyms	Names		
USB	universal serial bus		
BSL	bootstrap loader		
CAN	controller area network		
GND	ground		
GPIO	general purpose input output		
GUI	graphical user interface		
HID	human interface device		
LIN	local interconnect network		
MISO	master input slave output		
MOSI	master output slave input		
NAC	no activity counter		
NVM	non volatile memory		
PWM	pulse width modulation		
SBC	system basis chip		
SPI	serial peripheral interface		
UART	universal asynchronous receiver transmitter		
VS	voltage supply		



Revision history

Revision history

Document version	Date of release	Description of changes
1.00	2014-11-20	Initial version
1.10	2018-09-18	Updates, editorial changes
1.20	2021-12-10	Updates, editorial changes